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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/451,665	11/30/1999	SHUNPEI YAMAZAKI	07977/017002 9359		
26171 7:	590 11/15/2004		EXAMINER		
FISH & RICHARDSON P.C. 1425 K STREET, N.W.			SCHILLINGE	SCHILLINGER, LAURA M	
11TH FLOOR		•	ART UNIT	PAPER NUMBER	
WASHINGTO	N, DC 20005-3500		2813		

DATE MAILED: 11/15/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

			$\mathcal{A}_{\mathcal{C}}$
	Application No.		Applicant(s)
	09/451,665		YAMAZAKI ET AL. `
Office Action Summary	Examiner		Art Unit
	Laura M Schilling	,	2813
The MAILING DATE of this communication app Period for Reply	pears on the cover	sheet with the co	rrespondence address
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, howe by within the statutory min will apply and will expire to, cause the application to	ever, may a reply be time imum of thirty (30) days SIX (6) MONTHS from the become ABANDONED	ly filed will be considered timely. the mailing date of this communication. (35 U.S.C. § 133).
Status			
1)⊠ Responsive to communication(s) filed on <u>9/9/(</u>	04.		
•	action is non-fina	al.	
3)☐ Since this application is in condition for allowa	nce except for for	mal matters, pros	secution as to the merits is
closed in accordance with the practice under t	Ex parte Quayle,	1935 C.D. 11, 453	3 O.G. 213.
Disposition of Claims			
4) ☐ Claim(s) <u>1,2,4,5,7-13,15,16,18-23,25,26,28-34</u> 4a) Of the above claim(s) <u>See Continuation St</u> 5) ☐ Claim(s) is/are allowed. 6) ☑ Claim(s) <u>1,2,4,5 and 7-11</u> is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	neet is/are withdra	wn from consider	
Application Papers			
9)☐ The specification is objected to by the Examin			
10)☐ The drawing(s) filed on is/are: a)☐ acc			
Applicant may not request that any objection to the			
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E			
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documen 2. Certified copies of the priority documen 3. Copies of the certified copies of the priority documen application from the International Burea * See the attached detailed Office action for a list	ts have been rece ts have been rece prity documents ha nu (PCT Rule 17.2	eived. eived in Applicatio ave been received (a)).	on No. <u>08/620,462</u> . d in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 9/9/04.	5) 🗌	Interview Summary (Paper No(s)/Mail Dal Notice of Informal Pa Other:	

Continuation of Disposition of Claims: Claims withdrawn from consideration are 12,13,15,16,18-21,33,34,36,37,39-42,48-51 and 56-82.

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DETAILED ACTION

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

Claims 1-2, 4-5, and 7-11 are rejected under 35 U.S.C. 102(e) as being anticipated by Oka et al et al ('563).

In reference to claim 1, Oka et al teaches a method comprising:

forming a crystalline semiconductor film on an insulating surface (Col.17, lines: 40-45 Fig.5A (502))

forming an insulating film on the semiconductor film (Col.17, lines: 45-55 and Fig.5B (503)); introducing a first dopant through the insulating film by a first ion doping (Col.17, lines: 55-60 see also Col.15, lines: 45-55);

annealing the crystalline semiconductor film (Col.17, lines: 60-65);

forming a gate electrode over the insulating film (Col. 18, lines: 1-10 Fig. 5C (505)); and introducing a second dopant impurity into the crystalline semiconductor film by a second ion doping by using the gate as a mask (Col.18, lines: 50-60 and Fig.5C (507-508)),

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wherein a peak of a concentration of the first dopant profile is located in the insulating film Oka teaches that the silicon oxide layer is formed over the crystalline substrate prior to and during ion implantation Col.17, lines: 49-62. Since applicant's specification teaches that doing so produces peak concentration within the SiO(x) layer, it is inferred that Oka's same steps create the same results.)

In reference to claim 2, Oka et al teaches wherein the insulating film is SiO (Col. 17, line: 50).

In reference to claim 4, Oka et al teaches wherein the first dopant is B (Col. 17, lines: 59-60).

In reference to claim 5 Oka et al teaches wherein the semiconductor film is polycrystalline Si (Col. 17, lines: 40-45).

In reference to claim 7, Oka et al teaches wherein B is supplied by diborane gas (Col.17, lines: 59-60)

In reference to claim 8, Oka et al teaches wherein the insulating film is removed (Fig. 5F (503)-etching for contact holes).

In reference to claims 9 and 10, Oka fails to explicitly teach wherein the semiconductor device as the result of claim 1 is used in as a AMD nor a shift register having TFTs (however, the

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device as formed is automatically rejected with claim 1 and it is inherent that the device structure could be used in a AMD setting or as a shift register).

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Laura M Schillinger whose telephone number is (571) 272-1697. The examiner can normally be reached on M-T, R-F 7:00-5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Carl W Whitehead, Jr. can be reached on (571) 272-1702. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

LMS

10/26/04